AMD Xilinx - XC2V40-5FGG256I Datasheet

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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	64
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	88
Number of Gates	40000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v40-5fgg256i

Table 5: **Summary of Voltage Supply Requirements for All Input and Output Standards**

I/O Standard	V_{CCO}		V_{REF}	Termination Type	
	Output	Input	Input	Output	Input
LVDS_33	3.3	N/R	N/R[1]	N/R	N/R
LVDSEXT_33			N/R	N/R	N/R
LVPECL_33			N/R	N/R	N/R
SSTL3_I			1.5	N/R	N/R
SSTL3_II			1.5	N/R	N/R
AGP			1.32	N/R	N/R
LVTTL		3.3	N/R	N/R	N/R
LVCMOS33			N/R	N/R	N/R
LVDCI_33			N/R	Series	N/R
LVDCI_DV2_33			N/R	Series	N/R
PCI33_3			N/R	N/R	N/R
PCI66_3			N/R	N/R	N/R
PCIX			N/R	N/R	N/R
SSTL3_I_DCI			1.5	N/R	Split
SSTL3_II_DCI			1.5	Split	Split
LVDS_25	2.5	N/R	N/R	N/R	N/R
LVDSEXT_25			N/R	N/R	N/R
LDT_25			N/R	N/R	N/R
ULVDS_25			N/R	N/R	N/R
BLVDS_25			N/R	N/R	N/R
SSTL2_I			1.25	N/R	N/R
SSTL2_II			1.25	N/R	N/R
LVCMOS25		2.5	N/R	N/R	N/R
LVDCI_25			N/R	Series	N/R
LVDCI_DV2_25			N/R	Series	N/R
LVDS_25_DCI			N/R	N/R	Split
LVDSEXT_25_DCI			N/R	N/R	Split
SSTL2_I_DCI			1.25	N/R	Split
SSTL2_II_DCI			1.25	Split	Split

Table 5: **Summary of Voltage Supply Requirements for All Input and Output Standards *(Continued)***

I/O Standard	V_{CCO}		V_{REF}	Termination Type	
	Output	Input	Input	Output	Input
HSTL_III_18	1.8	N/R	1.1	N/R	N/R
HSTL_IV_18			1.1	N/R	N/R
HSTL_I_18			0.9	N/R	N/R
HSTL_II_18			0.9	N/R	N/R
SSTL18_I			0.9	N/R	N/R
SSTL18_II			0.9	N/R	N/R
LVCMOS18		1.8	N/R	N/R	N/R
LVDCI_18			N/R	Series	N/R
LVDCI_DV2_18			N/R	Series	N/R
HSTL_III_DCI_18			1.1	N/R	Single
HSTL_IV_DCI_18			1.1	Single	Single
HSTL_I_DCI_18			0.9	N/R	Split
HSTL_II_DCI_18			0.9	Split	Split
SSTL18_I_DCI			0.9	N/R	Split
SSTL18_II_DCI			0.9	Split	Split
HSTL_III	1.5	N/R	0.9	N/R	N/R
HSTL_IV			0.9	N/R	N/R
HSTL_I			0.75	N/R	N/R
HSTL_II			0.75	N/R	N/R
LVCMOS15		1.5	N/R	N/R	N/R
LVDCI_15			N/R	Series	N/R
LVDCI_DV2_15			N/R	Series	N/R
GTLP_DCI			1	Single	Single
HSTL_III_DCI			0.9	N/R	Single
HSTL_IV_DCI			0.9	Single	Single
HSTL_I_DCI			0.75	N/R	Split
HSTL_II_DCI			0.75	Split	Split
GTL_DCI	1.2	1.2	0.8	Single	Single
GTLP	N/R	N/R	1	N/R	N/R
GTL			0.8	N/R	N/R

Notes:
1. N/R = no requirement.

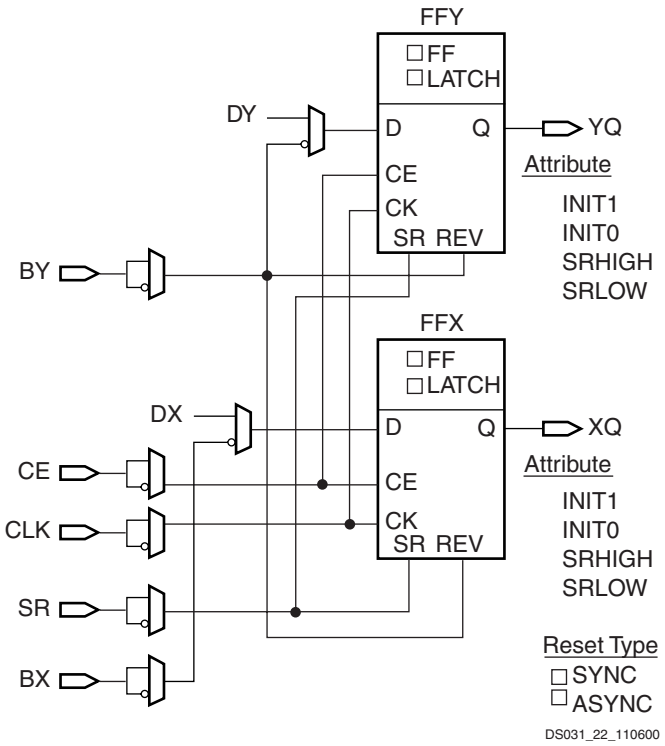

Figure 17: **Register / Latch Configuration in a Slice**

The set and reset functionality of a register or a latch can be configured as follows:

- No set or reset
- Synchronous set
- Synchronous reset
- Synchronous set and reset
- Asynchronous set (preset)
- Asynchronous reset (clear)
- Asynchronous set and reset (preset and clear)

The synchronous reset has precedence over a set, and an asynchronous clear has precedence over a preset.

Distributed SelectRAM Memory

Each function generator (LUT) can implement a 16 x 1-bit synchronous RAM resource called a distributed SelectRAM element. The SelectRAM elements are configurable within a CLB to implement the following:

- Single-Port 16 x 8 bit RAM
- Single-Port 32 x 4 bit RAM
- Single-Port 64 x 2 bit RAM
- Single-Port 128 x 1 bit RAM
- Dual-Port 16 x 4 bit RAM
- Dual-Port 32 x 2 bit RAM
- Dual-Port 64 x 1 bit RAM

Distributed SelectRAM memory modules are synchronous (write) resources. The combinatorial read access time is extremely fast, while the synchronous write simplifies high-speed designs. A synchronous read can be implemented with a storage element in the same slice. The distributed SelectRAM memory and the storage element share the same clock input. A Write Enable (WE) input is active High, and is driven by the SR input.

Table 9 shows the number of LUTs (2 per slice) occupied by each distributed SelectRAM configuration.

Table 9: **Distributed SelectRAM Configurations**

RAM	Number of LUTs
16 x 1S	1
16 x 1D	2
32 x 1S	2
32 x 1D	4
64 x 1S	4
64 x 1D	8
128 x 1S	8

Notes:
1. S = single-port configuration; D = dual-port configuration

For single-port configurations, distributed SelectRAM memory has one address port for synchronous writes and asynchronous reads.

For dual-port configurations, distributed SelectRAM memory has one port for synchronous writes and asynchronous reads and another port for asynchronous reads. The function generator (LUT) has separated read address inputs (A1, A2, A3, A4) and write address inputs (WG1/WF1, WG2/WF2, WG3/WF3, WG4/WF4).

In single-port mode, read and write addresses share the same address bus. In dual-port mode, one function generator (R/W port) is connected with shared read and write addresses. The second function generator has the A inputs (read) connected to the second read-only port address and the W inputs (write) shared with the first read/write port address.

Notice of Disclaimer

Virtex-II Data Sheet

The Virtex-II Data Sheet contains the following modules:

- Virtex-II Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Platform FPGAs: Functional Description (Module 2)
- Virtex-II Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Platform FPGAs: Pinout Information (Module 4)

Table 17: **IOB Output Switching Characteristics Standard Adjustments *(Continued)***

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
HSTL, Class II, 1.8V	HSTL_II_18	$T_{OHSTL\_II\_18}$	–0.17	–0.18	–0.20	ns
HSTL, Class III, 1.8V	HSTL_III_18	$T_{OHSTL\_III\_18}$	–0.16	–0.16	–0.18	ns
HSTL, Class IV, 1.8V	HSTL_IV_18	$T_{OHSTL\_IV\_18}$	–0.39	–0.40	–0.44	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V	SSTL18_I	$T_{OSSTL18\_I}$	0.20	0.20	0.22	ns
SSTL, Class II, 1.8V	SSTL18_II	$T_{OSSTL18\_II}$	–0.05	–0.05	–0.06	ns
SSTL, Class I, 2.5V	SSTL2_I	T_{OSSTL2_I}	0.21	0.22	0.24	ns
SSTL, Class II, 2.5V	SSTL2_II	T_{OSSTL2_II}	–0.15	–0.16	–0.18	ns
SSTL, Class I, 3.3V	SSTL3_I	T_{OSSTL3_I}	0.29	0.30	0.33	ns
SSTL, Class II, 3.3V	SSTL3_II	T_{OSSTL3_II}	–0.05	–0.05	–0.05	ns
AGP-2X/AGP (Accelerated Graphics Port)	AGP	T_{OAGP}	–0.27	–0.28	–0.31	ns
LVDCI (Low-Voltage Digitally Controlled Impedance), 3.3V	LVDCI_33	T_{OLVDCI_33}	0.74	0.77	0.84	ns
LVDCI, 2.5V	LVDCI_25	T_{OLVDCI_25}	0.78	0.80	0.88	ns
LVDCI, 1.8V	LVDCI_18	T_{OLVDCI_18}	0.84	0.87	0.95	ns
LVDCI, 1.5V	LVDCI_15	T_{OLVDCI_15}	1.82	1.88	2.06	ns
LVDCI, 3.3V, Half-Impedance	LVDCI_DV2_33	$T_{OLVDCI\_DV2\_33}$	0.12	0.12	0.13	ns
LVDCI, 2.5V, Half-Impedance	LVDCI_DV2_25	$T_{OLVDCI\_DV2\_25}$	0.03	0.03	0.03	ns
LVDCI, 1.8V, Half-Impedance	LVDCI_DV2_18	$T_{OLVDCI\_DV2\_18}$	0.42	0.43	0.48	ns
LVDCI, 1.5V, Half-Impedance	LVDCI_DV2_15	$T_{OLVDCI\_DV2\_15}$	1.20	1.23	1.36	ns
HSLVDCI (High-Speed Low-Voltage DCI), 1.5V	HSLVDCI_15	$T_{OHSLVDCI\_15}$	1.82	1.88	2.06	ns
HSLVDCI, 1.8V	HSLVDCI_18	$T_{OHSLVDCI\_18}$	1.05	1.08	1.24	ns
HSLVDCI, 2.5V	HSLVDCI_25	$T_{OHSLVDCI\_25}$	0.78	0.80	0.88	ns
HSLVDCI, 3.3V	HSLVDCI_33	$T_{OHSLVDCI\_33}$	0.74	0.77	0.84	ns
GTL (Gunning Transceiver Logic) with DCI	GTL_DCI	T_{OGTL_DCI}	–0.31	–0.32	–0.35	ns
GTL Plus with DCI	GTLP_DCI	T_{OGTLP_DCI}	–0.15	–0.16	–0.17	ns
HSTL (High-Speed Transceiver Logic), Class I, with DCI	HSTL_I_DCI	$T_{OHSTL\_I\_DCI}$	0.23	0.23	0.26	ns
HSTL, Class II, with DCI	HSTL_II_DCI	$T_{OHSTL\_II\_DCI}$	0.06	0.06	0.07	ns
HSTL, Class III, with DCI	HSTL_III_DCI	$T_{OHSTL\_III\_DCI}$	–0.17	–0.18	–0.20	ns
HSTL, Class IV, with DCI	HSTL_IV_DCI	$T_{OHSTL\_IV\_DCI}$	–0.46	–0.47	–0.52	ns
HSTL, Class I, 1.8V, with DCI	HSTL_I_DCI_18	$T_{OHSTL\_I\_DCI\_18}$	0.05	0.05	0.06	ns
HSTL, Class II, 1.8V, with DCI	HSTL_II_DCI_18	$T_{OHSTL\_II\_DCI\_18}$	–0.03	–0.03	–0.03	ns
HSTL, Class III, 1.8V, with DCI	HSTL_III_DCI_18	$T_{OHSTL\_III\_DCI\_18}$	–0.14	–0.14	–0.16	ns
HSTL, Class IV, 1.8V, with DCI	HSTL_IV_DCI_18	$T_{OHSTL\_IV\_DCI\_18}$	–0.41	–0.42	–0.47	ns
SSTL (Stub Series Terminated Logic), Class I, 1.8V, with DCI	SSTL18_I_DCI	$T_{OSSTL18\_I\_DCI}$	0.36	0.37	0.40	ns
SSTL, Class II, 1.8V, with DCI	SSTL18_II_DCI	$T_{OSSTL18\_II\_DCI}$	0.06	0.06	0.07	ns
SSTL, Class I, 2.5V, with DCI	SSTL2_I_DCI	$T_{OSSTL2\_I\_DCI}$	0.12	0.13	0.14	ns
SSTL, Class II, 2.5V, with DCI	SSTL2_II_DCI	$T_{OSSTL2\_II\_DCI}$	–0.10	–0.10	–0.11	ns
SSTL, Class I, 3.3V, with DCI	SSTL3_I_DCI	$T_{OSSTL3\_I\_DCI}$	0.15	0.16	0.17	ns
SSTL, Class II, 3.3V, with DCI	SSTL3_II_DCI	$T_{OSSTL3\_II\_DCI}$	0.08	0.08	0.09	ns

Output Clock Jitter

Table 40: **Output Clock Jitter**

Description	Symbol	Constraints	Speed Grade			Units
			-6	-5	-4	
Clock Synthesis Period Jitter						
CLK0	CLKOUT_PER_JITT_0		±100	±100	±100	ps
CLK90	CLKOUT_PER_JITT_90		±150	±150	±150	ps
CLK180	CLKOUT_PER_JITT_180		±150	±150	±150	ps
CLK270	CLKOUT_PER_JITT_270		±150	±150	±150	ps
CLK2X, CLK2X180	CLKOUT_PER_JITT_2X		±200	±200	±200	ps
CLKDV (integer division)	CLKOUT_PER_JITT_DV1		±150	±150	±150	ps
CLKDV (non-integer division)	CLKOUT_PER_JITT_DV2		±300	±300	±300	ps
CLKFX, CLKFX180	CLKOUT_PER_JITT_FX		Note 1	Note 1	Note 1	ps

Notes:
1. Values for this parameter are available at www.xilinx.com.

Output Clock Phase Alignment

Table 41: **Output Clock Phase Alignment**

Description	Symbol	Constraints	Speed Grade			Units
			-6	-5	-4	
Phase Offset Between CLKIN and CLKFB						
CLKIN/CLKFB	CLKIN_CLKFB_PHASE		±50	±50	±50	ps
Phase Offset Between Any DCM Outputs						
All CLK outputs	CLKOUT_PHASE		±140	±140	±140	ps
Duty Cycle Precision						
DLL outputs(1)	CLKOUT_DUTY_CYCLE_DLL(2)		±150	±150	±150	ps
CLKFX outputs	CLKOUT_DUTY_CYCLE_FX		±100	±100	±100	ps

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. CLKOUT_DUTY_CYCLE_DLL applies to the 1X clock outputs (CLK0, CLK90, CLK180, and CLK270) only if DUTY_CYCLE_CORRECTION = TRUE.
3. Specification also applies to PSCLK.

Miscellaneous Timing Parameters

Table 42: **Miscellaneous Timing Parameters**

Description	Symbol	Constraints F_{CLKIN}	Speed Grade			Units
			-6	-5	-4	
Time Required to Achieve LOCK						
Using DLL outputs(1)	LOCK_DLL					
	LOCK_DLL_60	> 60MHz	20.0	20.0	20.0	µs
	LOCK_DLL_50_60	50 - 60 MHz	25.0	25.0	25.0	µs
	LOCK_DLL_40_50	40 - 50 MHz	50.0	50.0	50.0	µs
	LOCK_DLL_30_40	30 - 40 MHz	90.0	90.0	90.0	µs
	LOCK_DLL_24_30	24 - 30 MHz	120.0	120.0	120.0	µs
Using CLKFX outputs	LOCK_FX_MIN		10.0	10.0	10.0	ms
	LOCK_FX_MAX		10.0	10.0	10.0	ms
Additional lock time with fine-phase shifting	LOCK_DLL_FINE_SHIFT		50.0	50.0	50.0	µs
Fine-Phase Shifting						
Absolute shifting range	FINE_SHIFT_RANGE		10.0	10.0	10.0	ns
Delay Lines						
Tap delay resolution	DCM_TAP_MIN		30.0	30.0	30.0	ps
	DCM_TAP_MAX		60.0	60.0	60.0	ps

Notes:
1. "DLL outputs" is used here to describe the outputs: CLK0, CLK90, CLK180, CLK270, CLK2X, CLK2X180, and CLKDV.
2. Specification also applies to PSCLK.

Frequency Synthesis

Table 43: **Frequency Synthesis**

Attribute	Min	Max
CLKFX_MULTIPLY	2	32
CLKFX_DIVIDE	1	32

Parameter Cross Reference

Table 44: **Parameter Cross Reference**

Libraries Guide	Data Sheet
DLL_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_{1X|2X|DV}_LF
DFS_CLKOUT_{MIN|MAX}_LF	CLKOUT_FREQ_FX_LF
DLL_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_DLL_LF
DFS_CLKIN_{MIN|MAX}_LF	CLKIN_FREQ_FX_LF
DLL_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_{1X|DV}_HF
DFS_CLKOUT_{MIN|MAX}_HF	CLKOUT_FREQ_FX_HF
DLL_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_DLL_HF
DFS_CLKIN_{MIN|MAX}_HF	CLKIN_FREQ_FX_HF

Table 6: **FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
5	IO_L01P_5/CS_B	T3		
6	IO_L01P_6	P1		
6	IO_L01N_6	N1		
6	IO_L02P_6/VRN_6	N3		
6	IO_L02N_6/VRP_6	N2		
6	IO_L03P_6	M4		
6	IO_L03N_6/VREF_6	M3		
6	IO_L04P_6	M2	NC	
6	IO_L04N_6	M1	NC	
6	IO_L06P_6	L4	NC	
6	IO_L06N_6	L3	NC	
6	IO_L43P_6	L2	NC	NC
6	IO_L43N_6	L1	NC	NC
6	IO_L45P_6	L5	NC	NC
6	IO_L45N_6/VREF_6	K5	NC	NC
6	IO_L91P_6	K4	NC	
6	IO_L91N_6	K3	NC	
6	IO_L93P_6	K2	NC	
6	IO_L93N_6/VREF_6	K1	NC	
6	IO_L94P_6	J4		
6	IO_L94N_6	J3		
6	IO_L96P_6	J2		
6	IO_L96N_6	J1		
7	IO_L96P_7	H1		
7	IO_L96N_7	H2		
7	IO_L94P_7	H3		
7	IO_L94N_7	H4		
7	IO_L93P_7/VREF_7	G1	NC	
7	IO_L93N_7	G2	NC	
7	IO_L91P_7	G3	NC	
7	IO_L91N_7	G4	NC	
7	IO_L45P_7/VREF_7	G5	NC	NC

Table 7: **FG456/FGG456 BGA — XC2V250, XC2V500, and XC2V1000**

Bank	Pin Description	Pin Number	No Connect in XC2V250	No Connect in XC2V500
5	IO_L06P_5	W6		
5	IO_L05N_5/VRP_5	V7		
5	IO_L05P_5/VRN_5	V6		
5	IO_L04N_5	AB5		
5	IO_L04P_5/VREF_5	AA5		
5	IO_L03N_5/D4/ALT_VRP_5	Y5		
5	IO_L03P_5/D5/ALT_VRN_5	W5		
5	IO_L02N_5/D6	AB4		
5	IO_L02P_5/D7	AA4		
5	IO_L01N_5/RDWR_B	Y4		
5	IO_L01P_5/CS_B	AA3		
6	IO_L01P_6	V5		
6	IO_L01N_6	U5		
6	IO_L02P_6/VRN_6	Y2		
6	IO_L02N_6/VRP_6	Y1		
6	IO_L03P_6	V4		
6	IO_L03N_6/VREF_6	V3		
6	IO_L04P_6	W2		
6	IO_L04N_6	W1		
6	IO_L06P_6	U4		
6	IO_L06N_6	U3		
6	IO_L19P_6	V2	NC	NC
6	IO_L19N_6	V1	NC	NC
6	IO_L21P_6	U2	NC	NC
6	IO_L21N_6/VREF_6	U1	NC	NC
6	IO_L22P_6	T5	NC	NC
6	IO_L22N_6	R5	NC	NC
6	IO_L24P_6	T4	NC	NC
6	IO_L24N_6	T3	NC	NC
6	IO_L43P_6	T2		
6	IO_L43N_6	T1		
6	IO_L45P_6	R4		
6	IO_L45N_6/VREF_6	R3		

FG676/FGG676 Fine-Pitch BGA Package

As shown in Table 8, XC2V1500, XC2V2000, and XC2V3000 Virtex-II devices are available in the FG676/FGG676 fine-pitch BGA package. Pins in the XC2V1500, XC2V2000, and XC2V3000 devices are the same, except for the pin differences in the XC2V1500 and XC2V2000 devices shown in the No Connect columns. Following this table are the FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch).

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
0	IO_L01N_0	D6		
0	IO_L01P_0	C6		
0	IO_L02N_0	B1		
0	IO_L02P_0	A2		
0	IO_L03N_0/VRP_0	D7		
0	IO_L03P_0/VRN_0	C7		
0	IO_L04N_0/VREF_0	B3		
0	IO_L04P_0	A3		
0	IO_L05N_0	G6		
0	IO_L05P_0	G7		
0	IO_L06N_0	E6		
0	IO_L06P_0	E7		
0	IO_L19N_0	B4		
0	IO_L19P_0	A4		
0	IO_L21N_0	B5		
0	IO_L21P_0/VREF_0	A5		
0	IO_L22N_0	B6		
0	IO_L22P_0	A6		
0	IO_L24N_0	A7		
0	IO_L24P_0	A8		
0	IO_L25N_0	E8	NC	NC
0	IO_L25P_0	D8	NC	NC
0	IO_L27N_0	G8	NC	NC
0	IO_L27P_0/VREF_0	F8	NC	NC
0	IO_L49N_0	C8		
0	IO_L49P_0	B8		
0	IO_L51N_0	D9		
0	IO_L51P_0/VREF_0	E9		
0	IO_L52N_0	F9		
0	IO_L52P_0	G9		
0	IO_L54N_0	B9		
0	IO_L54P_0	A9		
0	IO_L67N_0	C9		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
3	IO_L46P_3	Y26		
3	IO_L45N_3/VREF_3	U20		
3	IO_L45P_3	V20		
3	IO_L43N_3	W25		
3	IO_L43P_3	W24		
3	IO_L25N_3	V21	NC	NC
3	IO_L25P_3	W21	NC	NC
3	IO_L24N_3	AA26		
3	IO_L24P_3	AA25		
3	IO_L22N_3	Y24		
3	IO_L22P_3	Y23		
3	IO_L21N_3/VREF_3	W22		
3	IO_L21P_3	W23		
3	IO_L19N_3	AB26		
3	IO_L19P_3	AB25		
3	IO_L06N_3	AC26		
3	IO_L06P_3	AC25		
3	IO_L04N_3	AD26		
3	IO_L04P_3	AD25		
3	IO_L03N_3/VREF_3	AA24		
3	IO_L03P_3	AA23		
3	IO_L02N_3/VRP_3	AB24		
3	IO_L02P_3/VRN_3	AB23		
3	IO_L01N_3	Y22		
3	IO_L01P_3	AA22		
4	IO_L01N_4/BUSY/DOUT(1)	AD21		
4	IO_L01P_4/INIT_B	AC21		
4	IO_L02N_4/D0/DIN(1)	Y20		
4	IO_L02P_4/D1	Y19		
4	IO_L03N_4/D2/ALT_VRP_4	AA20		
4	IO_L03P_4/D3/ALT_VRN_4	AB20		
4	IO_L04N_4/VREF_4	AC22		
4	IO_L04P_4	AE21		
4	IO_L05N_4/VRP_4	AE26		
4	IO_L05P_4/VRN_4	AF25		
4	IO_L06N_4	W20		

Table 8: **FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000**

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
7	IO_L21P_7/VREF_7	F3		
7	IO_L21N_7	F2		
7	IO_L19P_7	H6		
7	IO_L19N_7	H7		
7	IO_L06P_7	E1		
7	IO_L06N_7	E2		
7	IO_L04P_7	D1		
7	IO_L04N_7	D2		
7	IO_L03P_7/VREF_7	C1		
7	IO_L03N_7	C2		
7	IO_L02P_7/VRN_7	E3		
7	IO_L02N_7/VRP_7	E4		
7	IO_L01P_7	G5		
7	IO_L01N_7	F4		
0	VCCO_0	J13		
0	VCCO_0	J12		
0	VCCO_0	J11		
0	VCCO_0	H10		
0	VCCO_0	H9		
0	VCCO_0	B10		
0	VCCO_0	B7		
1	VCCO_1	B17		
1	VCCO_1	J16		
1	VCCO_1	J15		
1	VCCO_1	J14		
1	VCCO_1	H18		
1	VCCO_1	H17		
1	VCCO_1	B20		
2	VCCO_2	N18		
2	VCCO_2	M18		
2	VCCO_2	L18		
2	VCCO_2	K25		
2	VCCO_2	K19		
2	VCCO_2	J19		
2	VCCO_2	G25		
3	VCCO_3	Y25		

Table 9: **BG575/BGG575 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in XC2V1000	No Connect in XC2V1500
7	VCCO_7	F3		
NA	CCLK	AB23		
NA	PROG_B	C1		
NA	DONE	AB21		
NA	M0	AC4		
NA	M1	AB4		
NA	M2	AD3		
NA	HSWAP_EN	C2		
NA	TCK	C23		
NA	TDI	D1		
NA	TDO	C24		
NA	TMS	C21		
NA	PWRDWN_B	AC21		
NA	DXN	B4		
NA	DXP	C4		
NA	VBATT	B21		
NA	RSVD	A22		
NA	VCCAUX	AD13		
NA	VCCAUX	AC22		
NA	VCCAUX	AC3		
NA	VCCAUX	N1		
NA	VCCAUX	M24		
NA	VCCAUX	B22		
NA	VCCAUX	B3		
NA	VCCAUX	A12		
NA	VCCINT	U17		
NA	VCCINT	U8		
NA	VCCINT	T16		
NA	VCCINT	T9		
NA	VCCINT	R15		
NA	VCCINT	R14		
NA	VCCINT	R13		
NA	VCCINT	R12		
NA	VCCINT	R11		

Table 10: **BG728 BGA — XC2V3000**

Bank	Pin Description	Pin Number
1	IO_L94N_1	C15
1	IO_L94P_1/VREF_1	D15
1	IO_L93N_1	E15
1	IO_L93P_1	F15
1	IO_L92N_1	G15
1	IO_L92P_1	H15
1	IO_L91N_1	J15
1	IO_L91P_1/VREF_1	J16
1	IO_L78N_1	A16
1	IO_L78P_1	B16
1	IO_L76N_1	D16
1	IO_L76P_1	E16
1	IO_L75N_1/VREF_1	F16
1	IO_L75P_1	F17
1	IO_L73N_1	H16
1	IO_L73P_1	H17
1	IO_L72N_1	A17
1	IO_L72P_1	B17
1	IO_L70N_1	C17
1	IO_L70P_1	D17
1	IO_L69N_1/VREF_1	G18
1	IO_L69P_1	G17
1	IO_L67N_1	A18
1	IO_L67P_1	B18
1	IO_L54N_1	C18
1	IO_L54P_1	D18
1	IO_L52N_1	E18
1	IO_L52P_1	F18
1	IO_L51N_1/VREF_1	H19
1	IO_L51P_1	H18
1	IO_L49N_1	A19
1	IO_L49P_1	A20
1	IO_L30N_1	B19
1	IO_L30P_1	C19
1	IO_L28N_1	D19
1	IO_L28P_1	E19

Table 11: **FF896 BGA — XC2V1000, XC2V1500, and XC2V2000**

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	M5		
NA	GND	K28		
NA	GND	K3		
NA	GND	H30		
NA	GND	H1		
NA	GND	G17		
NA	GND	G14		
NA	GND	F25		
NA	GND	F6		
NA	GND	E26		
NA	GND	E19		
NA	GND	E12		
NA	GND	E5		
NA	GND	D27		
NA	GND	D4		
NA	GND	C28		
NA	GND	C21		
NA	GND	C10		
NA	GND	C3		
NA	GND	B29		
NA	GND	B2		
NA	GND	A23		
NA	GND	A8		

Notes:
1. See Table 4 for an explanation of the signals available on this pin.

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	IO_L75N_7	R28	
7	IO_L74P_7	R26	
7	IO_L74N_7	P26	
7	IO_L73P_7	N31	
7	IO_L73N_7	P31	
7	IO_L72P_7	N30	
7	IO_L72N_7	P30	
7	IO_L71P_7	R25	
7	IO_L71N_7	P25	
7	IO_L70P_7	L34	
7	IO_L70N_7	M34	
7	IO_L69P_7/VREF_7	P29	
7	IO_L69N_7	N29	
7	IO_L68P_7	P27	
7	IO_L68N_7	N27	
7	IO_L67P_7	L32	
7	IO_L67N_7	M32	
7	IO_L54P_7	L31	
7	IO_L54N_7	M31	
7	IO_L53P_7	K29	
7	IO_L53N_7	L30	
7	IO_L52P_7	L33	
7	IO_L52N_7	M33	
7	IO_L51P_7/VREF_7	M29	
7	IO_L51N_7	L29	
7	IO_L50P_7	M28	
7	IO_L50N_7	N28	
7	IO_L49P_7	K30	
7	IO_L49N_7	K31	
7	IO_L48P_7	H32	
7	IO_L48N_7	J32	
7	IO_L47P_7	N26	
7	IO_L47N_7	M26	
7	IO_L46P_7	J33	
7	IO_L46N_7	K33	
7	IO_L45P_7/VREF_7	H33	

Table 12: **FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	VCCO_2	R11	
2	VCCO_2	R5	
2	VCCO_2	P12	
2	VCCO_2	P11	
2	VCCO_2	N12	
2	VCCO_2	N11	
2	VCCO_2	M11	
2	VCCO_2	K1	
2	VCCO_2	G4	
3	VCCO_3	AH4	
3	VCCO_3	AE1	
3	VCCO_3	AC11	
3	VCCO_3	AB12	
3	VCCO_3	AB11	
3	VCCO_3	AA12	
3	VCCO_3	AA11	
3	VCCO_3	Y12	
3	VCCO_3	Y11	
3	VCCO_3	Y5	
3	VCCO_3	W12	
3	VCCO_3	W1	
3	VCCO_3	V12	
4	VCCO_4	AP16	
4	VCCO_4	AP10	
4	VCCO_4	AL7	
4	VCCO_4	AK15	
4	VCCO_4	AD15	
4	VCCO_4	AD14	
4	VCCO_4	AD13	
4	VCCO_4	AD12	
4	VCCO_4	AC17	
4	VCCO_4	AC16	
4	VCCO_4	AC15	
4	VCCO_4	AC14	
4	VCCO_4	AC13	
5	VCCO_5	AP25	

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
0	IO_L76P_0	C24		
0	IO_L77N_0	K22		
0	IO_L77P_0	K21		
0	IO_L78N_0	E22		
0	IO_L78P_0	E23		
0	IO_L79N_0	B23		
0	IO_L79P_0	B24		
0	IO_L80N_0	J22		
0	IO_L80P_0	J21		
0	IO_L81N_0	G21		
0	IO_L81P_0/VREF_0	G22		
0	IO_L82N_0	A23		
0	IO_L82P_0	A24		
0	IO_L83N_0	H22		
0	IO_L83P_0	H21		
0	IO_L84N_0	F21		
0	IO_L84P_0	F22		
0	IO_L91N_0/VREF_0	B21		
0	IO_L91P_0	B22		
0	IO_L92N_0	L20		
0	IO_L92P_0	M20		
0	IO_L93N_0	E21		
0	IO_L93P_0	D22		
0	IO_L94N_0/VREF_0	A21		
0	IO_L94P_0	A22		
0	IO_L95N_0/GCLK7P	H20		
0	IO_L95P_0/GCLK6S	J20		
0	IO_L96N_0/GCLK5P	C21		
0	IO_L96P_0/GCLK4S	D21		
1	IO_L96N_1/GCLK3P	F19		
1	IO_L96P_1/GCLK2S	F20		
1	IO_L95N_1/GCLK1P	H19		
1	IO_L95P_1/GCLK0S	H18		
1	IO_L94N_1	C19		
1	IO_L94P_1/VREF_1	C20		

Table 13: **FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000**

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L93N_1	E19		
1	IO_L93P_1	E20		
1	IO_L92N_1	J19		
1	IO_L92P_1	J18		
1	IO_L91N_1	A18		
1	IO_L91P_1/VREF_1	A19		
1	IO_L84N_1	D18		
1	IO_L84P_1	D19		
1	IO_L83N_1	K19		
1	IO_L83P_1	K18		
1	IO_L82N_1	B18		
1	IO_L82P_1	B19		
1	IO_L81N_1/VREF_1	G18		
1	IO_L81P_1	G19		
1	IO_L80N_1	E18		
1	IO_L80P_1	E17		
1	IO_L79N_1	A16		
1	IO_L79P_1	A17		
1	IO_L78N_1	F17		
1	IO_L78P_1	F18		
1	IO_L77N_1	L19		
1	IO_L77P_1	L18		
1	IO_L76N_1	B16		
1	IO_L76P_1	B17		
1	IO_L75N_1/VREF_1	G16		
1	IO_L75P_1	G17		
1	IO_L74N_1	M19		
1	IO_L74P_1	M18		
1	IO_L73N_1	C16		
1	IO_L73P_1	C17		
1	IO_L72N_1	D15		
1	IO_L72P_1	D16		
1	IO_L71N_1	J17		
1	IO_L71P_1	J16		
1	IO_L70N_1	A14		
1	IO_L70P_1	A15		

BF957 Flip-Chip BGA Package

As shown in Table 14, XC2V2000, XC2V3000, XC2V4000, and XC2V6000 Virtex-II devices are available in the BF957 package. Pins in each of these devices are the same, except for the pin differences in the XC2V2000 device shown in the No Connect column. Following this table are the BF957 Flip-Chip BGA Package Specifications (1.27mm pitch).

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
0	IO_L01N_0	H23	
0	IO_L01P_0	H22	
0	IO_L02N_0	G24	
0	IO_L02P_0	E25	
0	IO_L03N_0/VRP_0	B29	
0	IO_L03P_0/VRN_0	C27	
0	IO_L04N_0/VREF_0	F24	
0	IO_L04P_0	F23	
0	IO_L05N_0	D26	
0	IO_L05P_0	D25	
0	IO_L06N_0	A28	
0	IO_L06P_0	A27	
0	IO_L19N_0	J22	
0	IO_L19P_0	J21	
0	IO_L20N_0	G23	
0	IO_L20P_0	G22	
0	IO_L21N_0	B27	
0	IO_L21P_0/VREF_0	B26	
0	IO_L22N_0	K20	
0	IO_L22P_0	K19	
0	IO_L23N_0	C26	
0	IO_L23P_0	C24	
0	IO_L24N_0	D24	
0	IO_L24P_0	D23	
0	IO_L25N_0	E24	NC
0	IO_L25P_0	E23	NC
0	IO_L26N_0	G21	NC
0	IO_L26P_0	G20	NC
0	IO_L27N_0	A26	NC
0	IO_L27P_0/VREF_0	A25	NC
0	IO_L29N_0	H21	NC
0	IO_L29P_0	H20	NC
0	IO_L30N_0	B25	NC
0	IO_L30P_0	B23	NC

Table 14: **BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000**

Bank	Pin Description	Pin Number	No Connect in XC2V2000
5	IO_L24P_5	AG23	
5	IO_L23N_5	AE22	
5	IO_L23P_5	AE23	
5	IO_L22N_5	AK25	
5	IO_L22P_5	AK26	
5	IO_L21N_5/VREF_5	AH25	
5	IO_L21P_5	AG25	
5	IO_L20N_5	AB21	
5	IO_L20P_5	AC22	
5	IO_L19N_5	AL27	
5	IO_L19P_5	AL28	
5	IO_L06N_5	AK27	
5	IO_L06P_5	AJ27	
5	IO_L05N_5/VRP_5	AD23	
5	IO_L05P_5/VRN_5	AE24	
5	IO_L04N_5	AJ26	
5	IO_L04P_5/VREF_5	AH26	
5	IO_L03N_5/D4/ALT_VRP_5	AF23	
5	IO_L03P_5/D5/ALT_VRN_5	AF24	
5	IO_L02N_5/D6	AG24	
5	IO_L02P_5/D7	AF25	
5	IO_L01N_5/RDWR_B	AK28	
5	IO_L01P_5/CS_B	AK29	
6	IO_L01P_6	AF27	
6	IO_L01N_6	AF28	
6	IO_L02P_6/VRN_6	AE26	
6	IO_L02N_6/VRP_6	AE27	
6	IO_L03P_6	AH29	
6	IO_L03N_6/VREF_6	AH30	
6	IO_L04P_6	AB22	
6	IO_L04N_6	AB23	
6	IO_L05P_6	AG28	
6	IO_L05N_6	AG29	
6	IO_L06P_6	AH31	
6	IO_L06N_6	AG31	
6	IO_L19P_6	AA22	
6	IO_L19N_6	Y22	